

Consumer Solutions

LOW TEMPERATURE CURE LSR TECHNOLOGY ENABLES PROCESSING IMPROVEMENTS

Craig Gross*, Michael Wang



OUTLINE



- Standard liquid silicone rubber (LSR) technology
- Standard condensation cure (hydrosilylation reaction)
- Low temperature cure (LTC) LSR
- LTC LSR advantages





LIQUID SILICONE RUBBER

- Two-part, dispensible, heat-cured silicone elastomers
- Good mechanical properties
- Excellent resistance to weathering, extreme temperatures, and aging
- LSR market growth at CAGR >8%
- Wide range of applications
 - > Transportation
 - Food/hygiene/medical
 - Electrical/electronics
- Overall trend for optimum quality, processing and efficieny

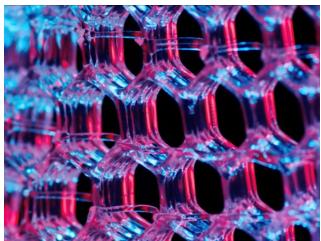




CONDENSATION CURE

- Pt-catalyzed hydrosilylation
- Addition of silicon hydrides (SiH) to unsaturated groups
- Reaction readily proceeds at 23°C
- Additives often included to provide handling time by inhibiting cure at room temperature
- Typically cure is heat activated

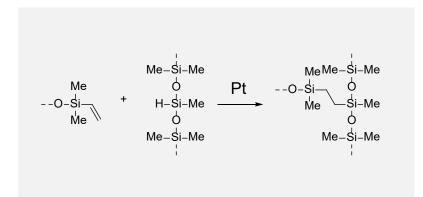


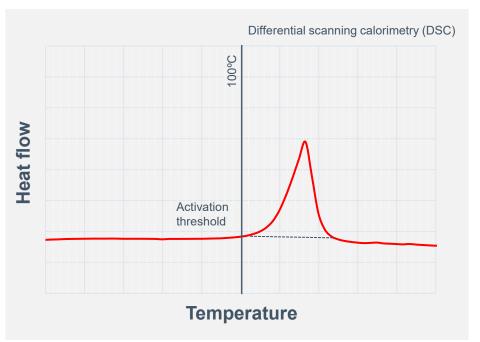




STANDARD CURE

- LSRs generally have a high activation threshold
- Standard cure temperature range from 160-220°C

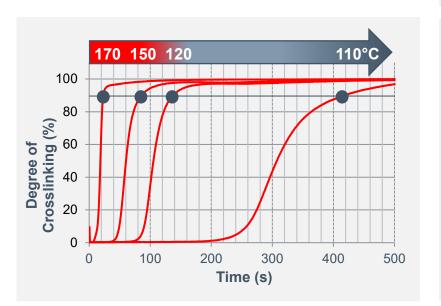


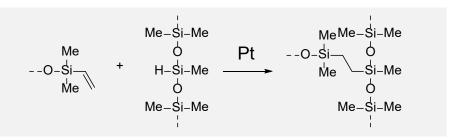


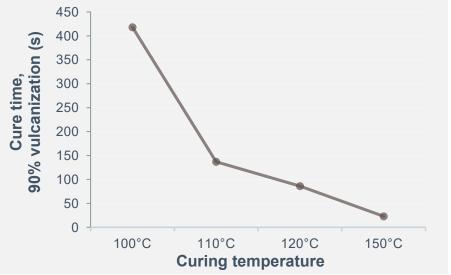


STANDARD CURE

- Reaction rate is temperature dependent
- Cure time increases as temperatures decrease









LOW TEMPERATURE CURE (LTC)

Low Temperature Cure (LTC) LSR:

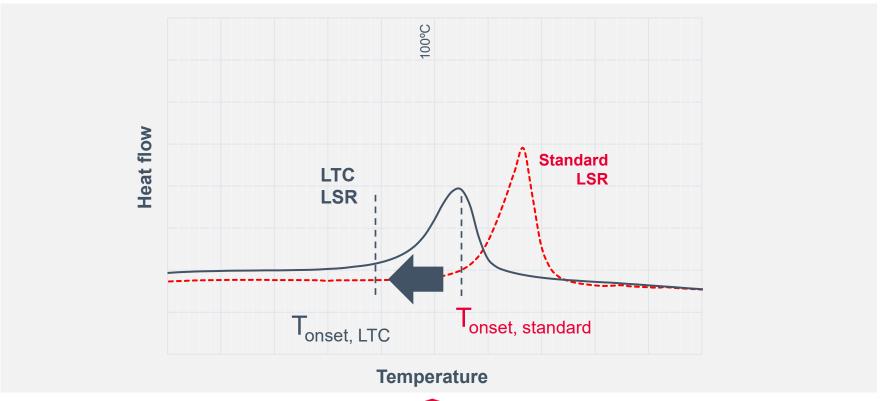
- New LSR with lower cure activation temperature
- Can be used with conventional injection molding equipment and tooling
- Fast deep section cure at elevated temperatures
- Fast curing at temperatures as low as 90°C





LOW TEMPERATURE CURE (LTC)

Activation threshold shifted to temperatures <100°C

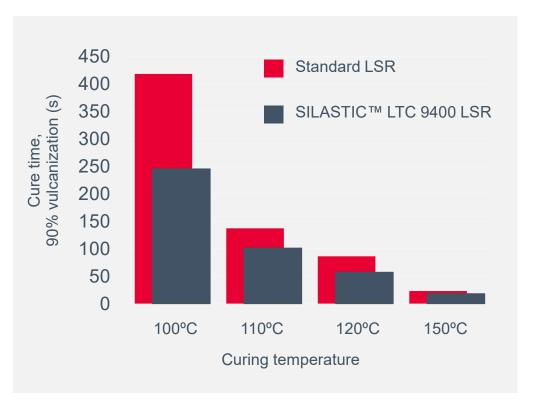




LOW TEMPERATURE CURE (LTC)

Low Temperature Cure (LTC) LSR:

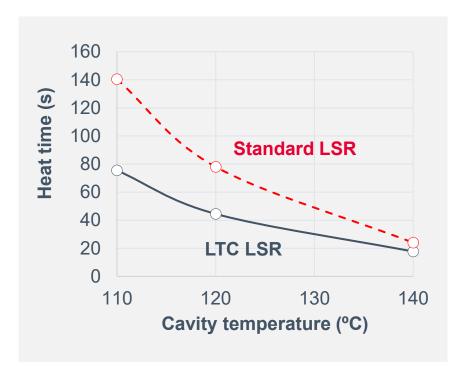
- Significant reduction of curing time at low temperatures (<120°C)
- 72 h pot life still maintained





LTC LSR INJECTION MOLDING

Heating time at lower temperature reduced by up to 46%

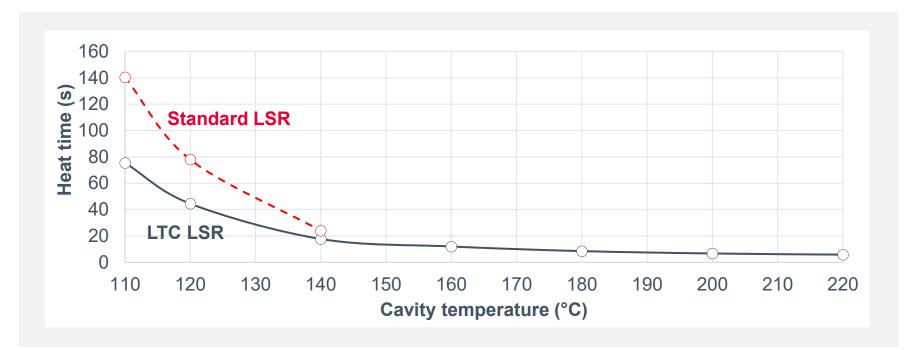




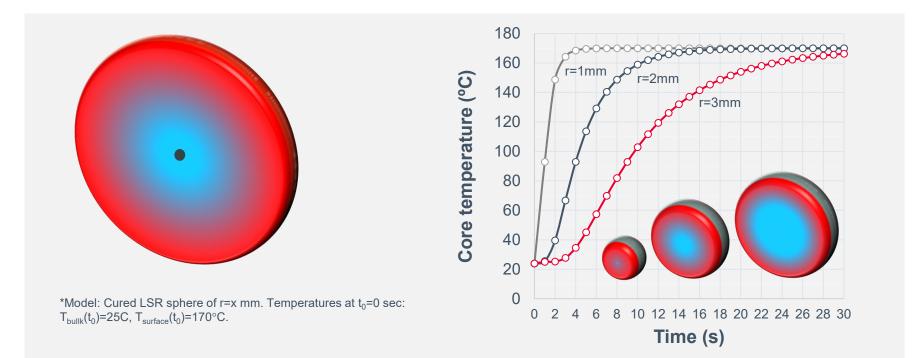


LTC LSR INJECTION MOLDING

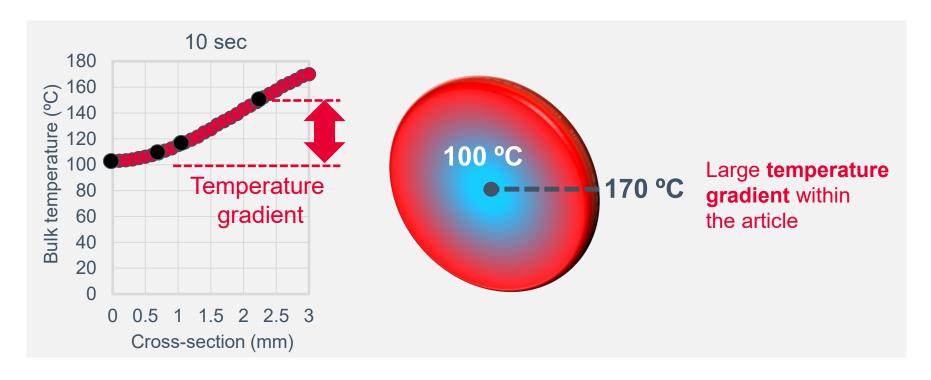
- Heating time at lower temperature reduced by up to 46%
- Low temperature cure at high temperatures possible



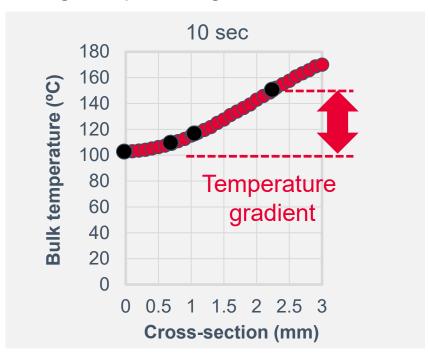
LSRs, and silicones in general, have low thermal conductivity

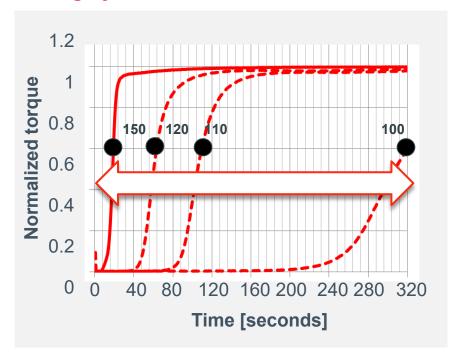


LSRs, and silicones in general, have low thermal conductivity



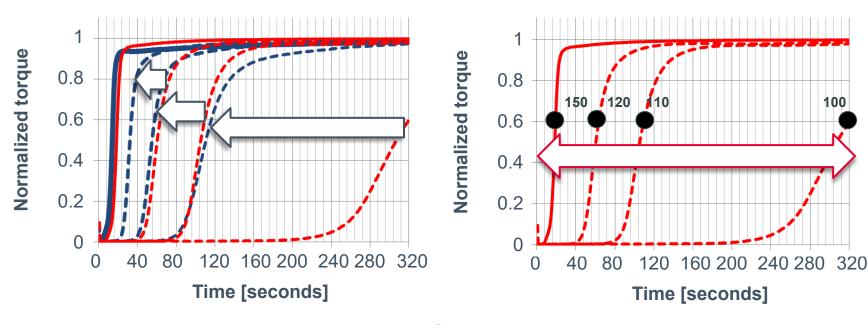
- LSRs, and silicones in general, have low thermal conductivity
- Large temperature gradient within the article = long cycle times





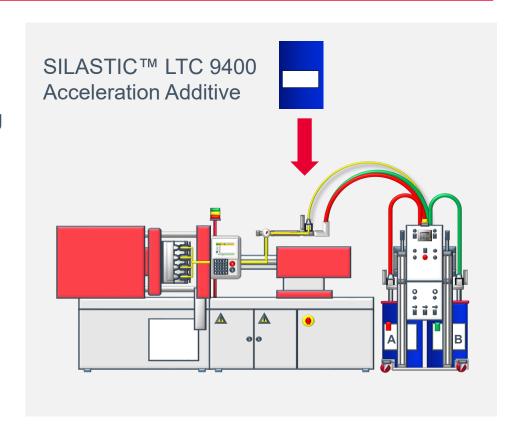


- LSRs, and silicones in general, have low thermal conductivity
- Large temperature gradient within the article = long cycle times
- LTC LSR shows <u>significantly reduced</u> sensitivity to temperature gradients



LTC ACCELERATION ADDITIVE

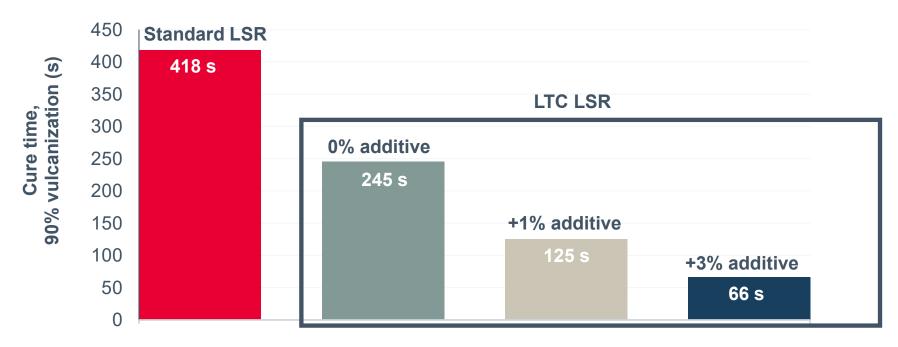
- Lower temperature cure achievable with additive
- Acceleration additive can be introduced via 3rd stream color dosing
- Tailored to match activation profile of SILASTIC™ LTC 9400 Series LSRs
- Allows on/off operation for robust processing and pot life control
- Large effect at low dosage levels (1-3%)





LTC ACCELERATION ADDITIVE

Significant impact on cure time, even at low dosage levels (1-3%)

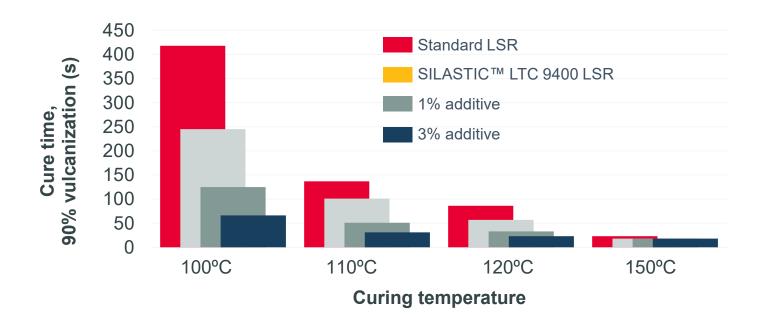


100°C Curing temperature



LTC ACCELERATION ADDITIVE

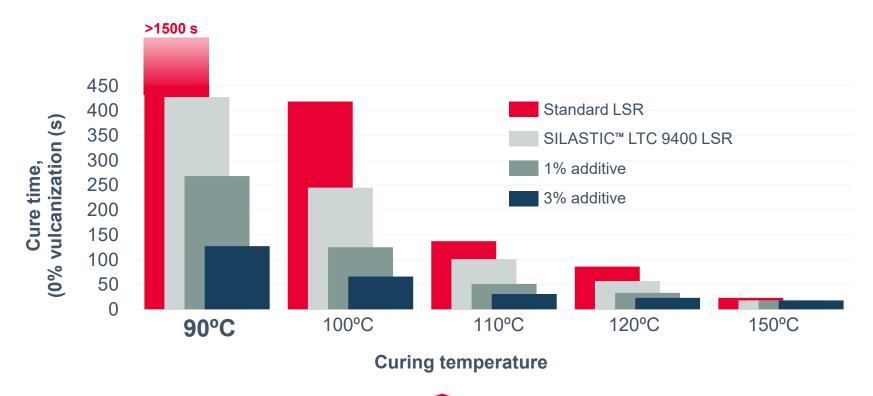
- Significant impact on cure time, even at low dosage levels (1-3%)
- Decreases temperature sensitivity at lower temperatures





LTC Acceleration Additive

Impact of LTC and acceleration additive more significant at cure temperatures <100°C

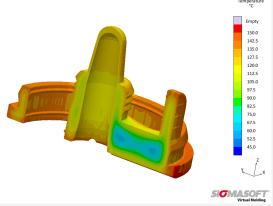


DEEP-SECTION CURE MODELING AND VALIDATION

- Low Temperature Cure acceleration demonstrated with SILASTIC™ LTC 9400-50 LSR
- Further reduce sensitivity to temperature gradients
- SILASTIC™ LTC 9400 Acceleration Additive introduced at 0.5%
- 30 s total cycle time achieved at 160°C

Simulated by SIGMASOFT: Temperature distribution after 20 s

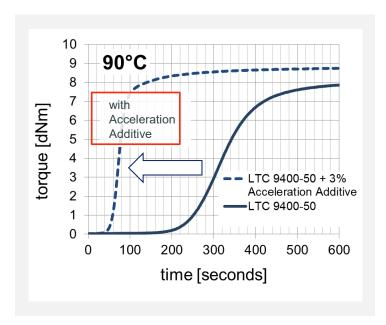


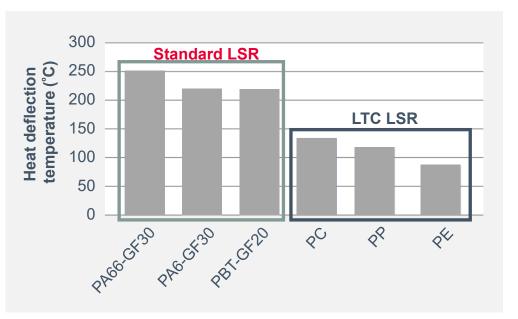




CO-MOLDING WITH PLASTICS

- LTC LSR allows fast curing at low temperatures
- Avoids plastic deformation
- Fast cycle time







CONCLUSIONS

- Low temperature cure is a novel technology platform for LSRs
- Step-change reduction in curing temperatures, <120°C
- Acceleration additive allows reasonable cure times at temperatures <100°C
- Can provide several benefits compared to traditional LSRs:
 - Lower operating temperatures
 - Shorter process cycle times
 - Faster bulk activation
 - Better deep-section cure
 - Ability to co-mold with wider range of substrates





Seek

TogetherTM

THANK YOU

Presented at the

196th Technical Meeting of the Rubber Division, ACS International Elastomer Conference Cleveland, OH, October 10, 2019

The information contained in this communication does not constitute an offer, does not give rise to binding obligations, and is subject to change without notice to you. The creation of binding obligations will occur only if an agreement is signed by authorized representatives of Dow and your company. Any reference to competitor materials contained in this communication is not an endorsement of those materials by Dow or an endorsement by the competitor of Dow materials.

To the fullest extent permitted by applicable law, Dow disclaims any and all liability with respect to your use or reliance upon the information. DOW DOES NOT MAKE ANY WARRANTY OR REPRESENTATION, EXPRESS OR IMPLIED, WITH RESPECT TO THE UTILITY OR COMPLETENESS OF THE INFORMATION AND DISCLAIMS THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. DOW DISCLAIMS LIABILITY FOR ANY INCIDENTAL OR CONSEQUENTIAL DAMAGES.

®™Trademark of The Dow Chemical Company ("Dow") or an affiliated company of Dow
© 2025 The Dow Chemical Company. All rights reserved.

2000024825-63804

Form No. 45-1652-01-0225 S2D